	Material Composit © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	Il rights reserved ntions.	under both	This docum level parts, t	ent is a declarat	ion of the su encompasse	ubstances v s all lower	within the manufacture level materials for w	urer listed which the 1	tem. Note: nanufacture	if the item is an as er has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information				
upplier Informat	tion														
Company name*			Company unique ID				Unique ID Authority				Respon	Response Date*			
onsemi											2025-00	2025-06-07			
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative				Phone - Representative*				Email -	Email - Representative*			
Product-Env-Steward	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com					
Requester I	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Ma		Manufacturing Site		Weight*	UOM	Unit Type		
		CAT25128XI-T2 128KE		128KB SPI SER	28KB SPI SER CMOS EEPROM		2025-06-07		Т	TH6		135.21	mg	Each	
Ianufacturing Pr	occess Information	n													
Terminal Plating / Grid Array Material Terr			erminal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperatu		are Max Time at Peak Tempera		ture Num	ber of Reflow Cy	cles			
Matte Tin (Sn) - annealed			CU Alloy 3			260 C		30	seco	nds 3					
omments															
FTENTION: MSL 3	Rated item requires Ba	ke and D	ry Pack (after	electrical test)											
or more information	regarding material con	position	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl bhthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.12	mg	Supplier	Silicon (Si)	7440-21-3		3.12	mg
Die Attach	0.42	mg	Supplier	Silver (Ag)	7440-22-4		0.315	mg
			Supplier	Epoxy resins	129915-35-1		0.105	mg
Lead Frame	44.7	mg	Supplier	Silver (Ag)	7440-22-4		0.3576	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0536	mg
			Supplier	Iron (Fe)	7439-89-6		1.0504	mg
			Supplier	Copper (Cu)	7440-50-8		43.2249	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0134	mg
Mold Compound-Black	85.59	5.59 mg		Epoxy Phenol Resin	proprietary data		8.9869	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		76.603	mg
Plating	1.21	mg	Supplier	Tin (Sn)	7440-31-5		1.21	mg
Wire Bond - Au	0.17	mg	Supplier	Gold (Au)	7440-57-5		0.17	mg